



# Product Change Notification

## 112311 - 00

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# Product Change Notification

**Change Notification #:** 112311 - 00  
**Change Title:** Intel® SSD 313 Series (20GB, 24GB)  
PCN 112311-00, Product Discontinuance  
End of Life  
**Date of Publication:** June 17, 2013

## Key Characteristics of the Change:

Product Discontinuance

## Forecasted Key Milestones:

<b>Product Discontinuance Program Support Begins:</b>	Jun 17, 2013
<b>Product Discontinuance Demand To Local Intel Representative:</b>	Aug 05, 2013
<b>Last Product Discontinuance Order Date:</b>	Sep 20, 2013
<b>Last Product Discontinuance Shipment Date:</b>	Dec 20, 2013

## Description of Change to the Customer:

Intel is announcing the End of Life timeline for the Intel® SSD 313 Series.

The Intel® SSD 313 Series products listed on the "Products Affected/Intel Ordering Codes" table below will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date".

## Customer Impact of Change and Recommended Action:

Intel will make commercially reasonable efforts to support last time order quantities. However, due to supply limitations, customer orders may be fulfilled from the Intel® SSD on 20nm Intel NAND product line. Please note: supply constraints may create situations where we are unable to support customer demand with available 25nm and 20nm products.

For applicable replacement product(s), customers should transition to the latest available Intel® Solid State Drive on 20nm Intel NAND or contact their field sales person.

## Products Affected / Intel Ordering Codes:

Product Name	Product Code	Affected MM#
Intel® SSD 313 Series (20GB, mSATA 3Gb/s, 25nm, SLC) 3.6mm, OEM Pack	SSDMAEXC020G301	918892
Intel® SSD 313 Series (20GB, 2.5in SATA 3Gb/s, 25nm, SLC) 9.5mm, OEM Pack	SSDSA2VP020G301	918893
Intel® SSD 313 Series (24GB, mSATA 3Gb/s, 25nm, SLC) 3.6mm, OEM Pack	SSDMAEXC024G301	918894
Intel® SSD 313 Series (24GB, 2.5in SATA 3Gb/s, 25nm, SLC) 9.5mm, OEM Pack	SSDSA2VP024G301	918895

**PCN Revision History:**

**Date of Revision:**

June 17, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN